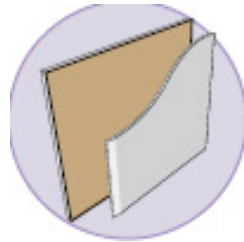


Description: - Gypboard® Plain



Characteristics: Standard board product (Gypsum core firmly bonded with strong paper liners)

Application:

Suitable for most applications where normal fire, Structural and acoustic levels are specified.

Applicable Standard: IS 2095 (Part 1):2011

Properties:

Thermal Conductivity: 0.16 (w/m⁰K)
 Thermal resistance: 0.059 for 9.5mm thick board
 0.078 for 12.5mm thick board
 0.093 for 15mm thick board

Board Colour: Gray face paper
 Brown reverse side paper

Edges: Taper edge along length of board
 Square edge along width of board

Flexural breaking load of Gypboard® Plain as per IS 2095 (Part 1):2011

Width mm	Length mm	Transverse Direction (N)	Longitudinal Direction (N)
9.5mm board			
1219	1829	140	360
12.5mm board			
1219	1829	180	500
1219	2438	180	500
15mm board			
1219	1829	220	650
1219	2438	220	650